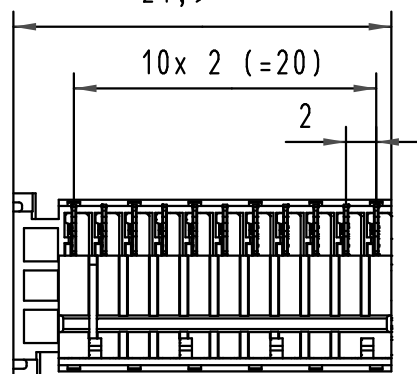
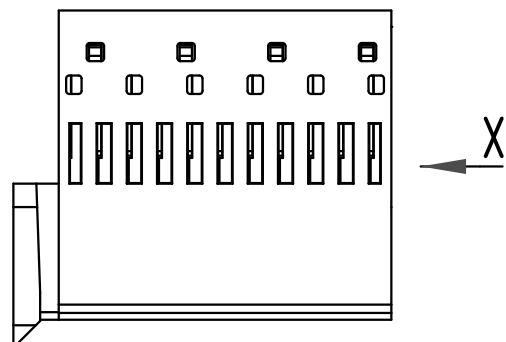
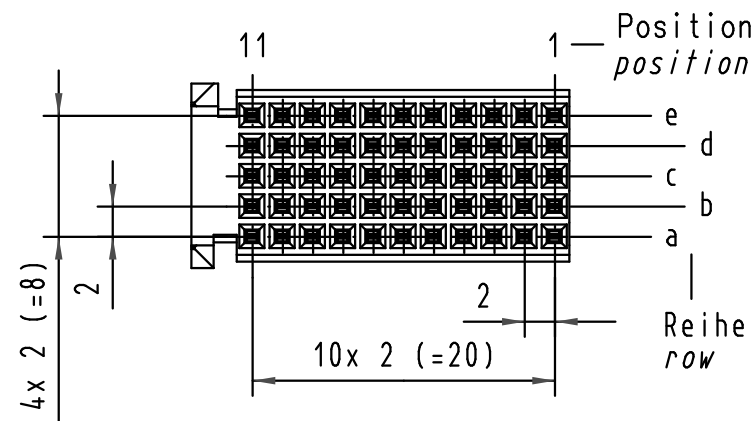
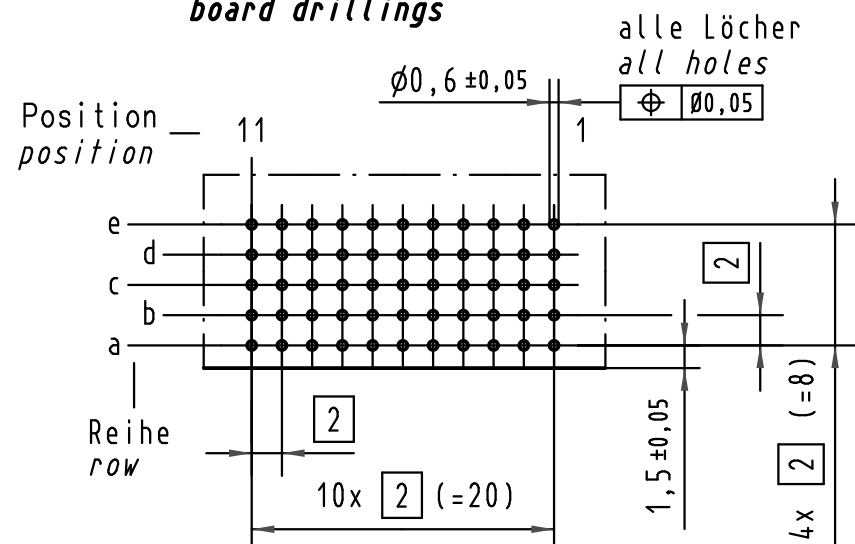
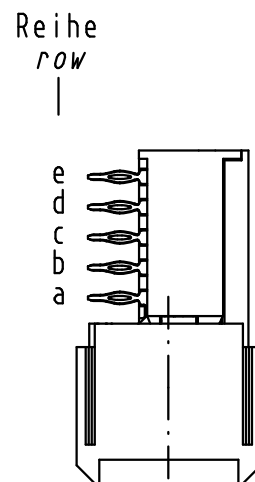
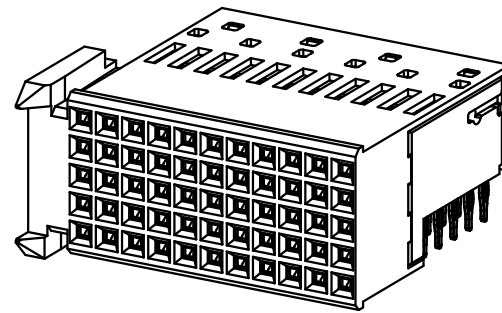




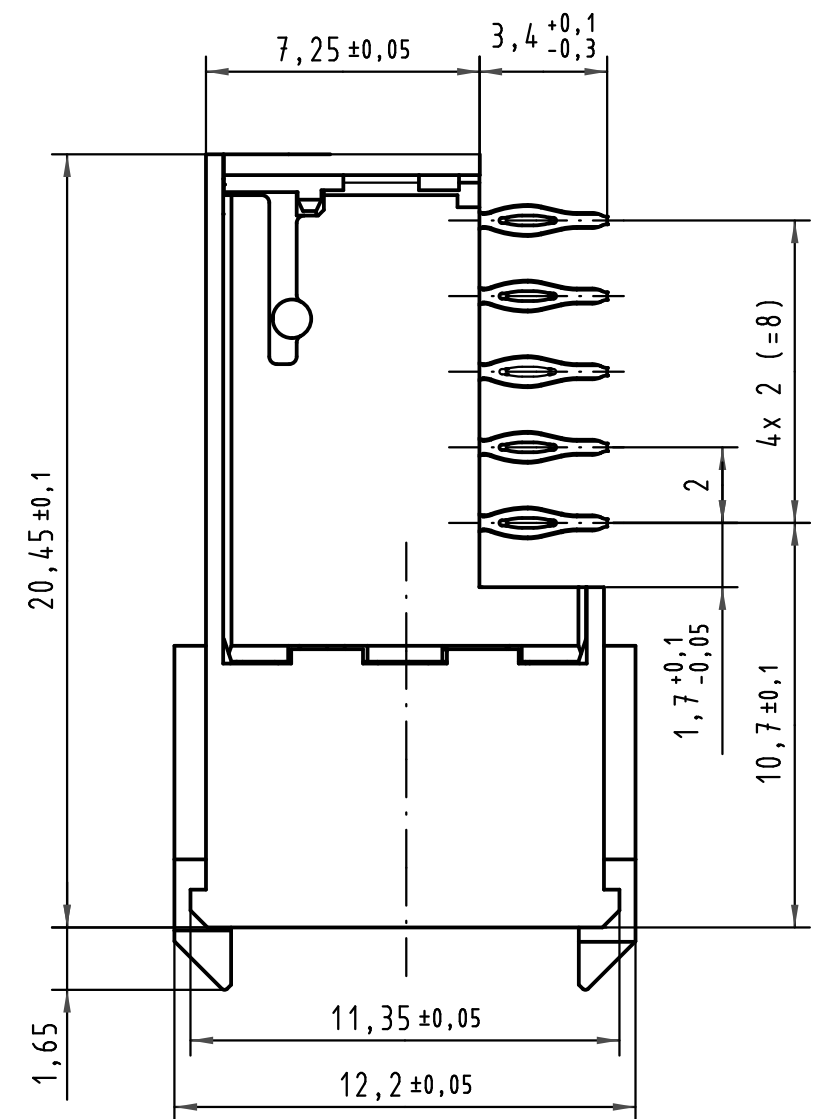
Lochbild board drillings



Bohrlochdurchmesser: $\phi 0,7 \pm 0,02$ mm
 Lochdurchmesser (mit Oberfläche): $\phi 0,6 \pm 0,05$ mm
 drill hole dia.: $\phi 0,7 \pm 0,02$ mm
 through hole dia. (after plating): $\phi 0,6 \pm 0,05$ mm



X
5:1



17 23 055 4101	—	min. 0,76 μ m (30 μ m) Au über/over min. 1,27 μ m (50 μ m) Ni
17 23 055 2101	2	Au über/over Ni
17 23 055 1101	1	Au über/over Ni
Bestell-Nr. part-no.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche contact plating

			All Dimensions in mm Original Size DIN A 3			Techn. Character.			Nicht tolerierte Maß/Free size tolerances IEC 61076-4-101		
34650	01.02.08	Hage.		Dat.	Name	Maßstab/Scale 2:1 (5:1)	har-bus HM Federleiste, Typ C, 55 pol. <i>har-bus HM female connector, type C, 55 pol.</i>				
30074	03.08.01	Wi	Detail.	30.10.97	Hm						
26047	20.05.99	Hm	Insp.	30.10.97	Ko						
25017	22.09.98	Hm	Stand.								
24594	06.08.98	Hm	HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP				TB 17 23 055 x101		Blatt/ page /		
22833											
Mod.	Dat.	Name				Sub.					